501978959 07/05/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Byung Tai Do	06/27/2012
Arnel Senosa Trasporto	06/27/2012
Linda Pei Ee Chua	06/27/2012

RECEIVING PARTY DATA

Name:	STATS ChipPAC Ltd.
Street Address:	10 Ang Mo Kio Street 65
Internal Address:	#05-17/20 Techpoint
City:	Singapore
State/Country:	SINGAPORE
Postal Code:	569059

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13542120

CORRESPONDENCE DATA

Fax Number: (408)738-0881 Phone: 408-738-0592

Email: efiling@ishimarulaw.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US

Mail.

Correspondent Name: ISHIMARU & ASSOCIATES LLP

Address Line 1: 2055 Gateway Place

Address Line 2: Suite 700

Address Line 4: San Jose, CALIFORNIA 95110

ATTORNEY DOCKET NUMBER:	27-868
NAME OF SUBMITTER:	Stanley Chang

Total Attachments: 3

source=27-868_Assignment#page1.tif source=27-868_Assignment#page2.tif source=27-868_Assignment#page3.tif

> PATENT REEL: 028494 FRAME: 0902

Docket No.: 27-868

ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

INTEGRATED CIRCUIT PACKAGING SYSTEM WITH GRID-ARRAY MECHANISM AND METHOD OF MANUFACTURE THEREOF

for which a United States patent application has been executed on or before the date of this assignment;

WHEREAS, <u>STATS ChipPAC Ltd.</u> a Corporation of the <u>Republic of Singapore</u>, having a place of business at 10 Ang Mo Kio Street 65, #05-17/20 Techpoint, Singapore 569059, Republic of Singapore (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee(s), the receipt of which is hereby acknowledged by said Assignor(s):

- 1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee(s), the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
- 2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee(s) where said Assignee(s) may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee(s)) which are deemed necessary or desirable by Assignee(s) to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee(s)) which are deemed necessary or desirable by Assignee(s) for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee(s).
- 3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee(s), its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
- 4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

l of 3

Docket No.: 27-868

5.	Said	Ass	signor(s)	hereby	authori	zes	and	reques	sts	the	attor	ney(s)	of	record	in	this
app	licatio	n to	insert th	e serial	number	and	filin	g date	of	this	Non	Provis	iona	l appli	catio	n in
the	spaces	that	t follow:													

Sorial Hamber.	Serial Number:	13/542,120	Filing Date:	July 5, 2012
----------------	----------------	------------	--------------	--------------

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

Stu	27 Jun 2012
Byung Tai Do	Date
Arr	3/14.2/~
Witness Signature	Witness Signature
LM GM GONG	SUM YOKE YEE
Print Witness Name	Print Witness Name
27 June 12	27 Jun'1>
Date	Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

Marpul_	27 Jun 2012
Arnel Senosa Trasporto	Date
AN	31/11/A
Witness Signature	Witness Signature
LAT GAT LEONG	Sum Yorke Yee
Print Witness Name	Print Witness Name
27 June 12	27 JUN'12
Date	Date

Docket No.: 27-868 ASSIGNMENT

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

As-	27 Jun 2012
Linda Pei Ee Chua	Date
Fin	AUA.
Witness Signature	Witness Signature
LAT WAT LEONLY	Sum Yoke Yee
Print Witness Name	Print Witness Name
ez June 12	27 Jm 12
Date	Date